

Is Now Part of



ON Semiconductor®

To learn more about ON Semiconductor, please visit our website at <u>www.onsemi.com</u>

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor dates sheds, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor dates sheds and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use on similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor and its officers, employees, subsidiaries, affliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out or i, directly or indirectly, any lay bed ON Semiconductor and its officers, employees, ween if such claim alleges that ON Semiconductor was negligent regarding the d

October 2001

FAIRCHILD

FDN327N

N-Channel 1.8 Vgs Specified PowerTrench[®] MOSFET

General Description

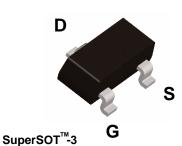
This 20V N-Channel MOSFET uses Fairchild's high voltage PowerTrench process. It has been optimized for power management applications.

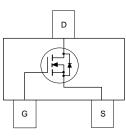
Applications

- Load switch
- Battery protection
- Power management

Features

- Low gate charge (4.5 nC typical)
- Fast switching speed
- + High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$





Absolute Maximum Ratings T_A=25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V _{DSS}	Drain-Source Voltage		20	
V _{GSS}	Gate-Source Voltage		± 8	V
I _D	Drain Current – Continuous (Note 1a)		2 A	
	– Pulsed		8	
P _D	Power Dissipation for Single Operation	Note 1a)	0.5	W
		(Note 1b)	0.46	
T _J , T _{STG}	Operating and Storage Junction Tempo	erature Range	–55 to +150 °C	
	I Characteristics		050	
R _{0JA}	Thermal Resistance, Junction-to-Ambi	ent (Note 1a)		
	'	· · ·		°C/W
	Thermal Resistance, Junction-to-Case	· · ·	75	
R _{θJC}	'	(Note 1)	75	°C/W
R _{əjc} Packag	Thermal Resistance, Junction-to-Case	(Note 1)	75 Tape width	

©2001 Fairchild Semiconductor Corporation

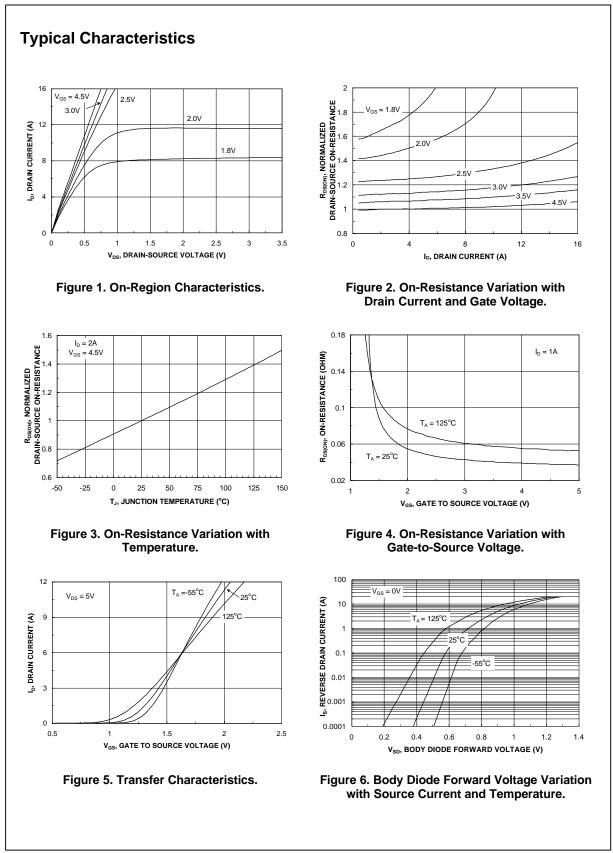
FDN327N

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics					l
BV _{DSS}	Drain–Source Breakdown Voltage	$V_{GS} = 0 V$, $I_D = 250 \mu A$	20			V
<u>ΔBVdss</u> ΔTj	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}, \text{Referenced to } 25^{\circ}\text{C}$		12		mV/°C
DSS	Zero Gate Voltage Drain Current	$V_{DS} = 16 V$, $V_{GS} = 0 V$			1	μΑ
GSSF	Gate-Body Leakage, Forward	$V_{GS} = 8 V$, $V_{DS} = 0 V$			100	nA
GSSR	Gate-Body Leakage, Reverse	$V_{GS} = -8 \text{ V}, \qquad V_{DS} = 0 \text{ V}$			-100	nA
On Char	acteristics (Note 2)	·	•		•	
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	0.4	0.7	1.5	V
$\Delta V_{GS(th)}$ ΔT_J	Gate Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}, \text{Referenced to } 25^{\circ}\text{C}$		-3		mV/°C
R _{DS(on)}	Static Drain–Source On–Resistance	$ \begin{array}{l} V_{GS} = 4.5 \ V, I_D = 2.0 \ A \\ V_{GS} = 2.5 \ V, I_D = 1.9 \ A \\ V_{GS} = 1.8 \ V, I_D = 1.6 \ A \\ V_{GS} = 4.5 \ V, \ I_D = 2 \ A, \ T_J = 125^\circ C \end{array} $		40 49 65 55	70 80 120 103	mΩ
D(on)	On–State Drain Current	$V_{GS} = 4.5V, V_{DS} = 5V$	8			Α
g _{FS}	Forward Transconductance	$V_{DS} = 5V,$ $I_D = 2A$		11		S
	Characteristics					
C _{iss}	Input Capacitance	V _{DS} = 10 V, V _{GS} = 0 V f = 1.0 MHz		423		pF
C _{oss}	Output Capacitance			87		pF
C _{rss}	Reverse Transfer Capacitance			48		pF
Switchin	g Characteristics (Note 2)					
d(on)	Turn–On Delay Time	$ \begin{array}{c} V_{\text{DD}} = 10 \ \text{V}, & I_{\text{D}} = 1 \ \text{A}, \\ V_{\text{GS}} = 4.5 \ \text{V}, & R_{\text{GEN}} = 6 \ \Omega \end{array} $		6	12	ns
r	Turn–On Rise Time			6.5	13	ns
d(off)	Turn–Off Delay Time			14	29	ns
f	Turn–Off Fall Time	_		2	4	ns
Ĵ	Total Gate Charge	$V_{DS} = 10 \text{ V}, \qquad I_D = 2 \text{ A},$		4.5	6.3	nC
Q _{gs}	Gate-Source Charge	$V_{GS} = 4.5 V$		0.89		nC
Q _{gd}	Gate-Drain Charge			0.95		nC
Drain-So	ource Diode Characteristics	and Maximum Ratings				
ls	Maximum Continuous Drain-Source				0.42	Α
V _{SD}	Drain–Source Diode Forward Voltage	$V_{GS} = 0 V$, $I_S = 0.42 A$ (Note 2)		0.6	1.2	V
	um of the junction-to-case and case-to-ambient the is. R _{6JC} is guaranteed by design while R _{6CA} is dete a) 250°C/W when mounted on a 0.02 in pad of 2 oz. copper.			l as the so	lder mounti	ng surface

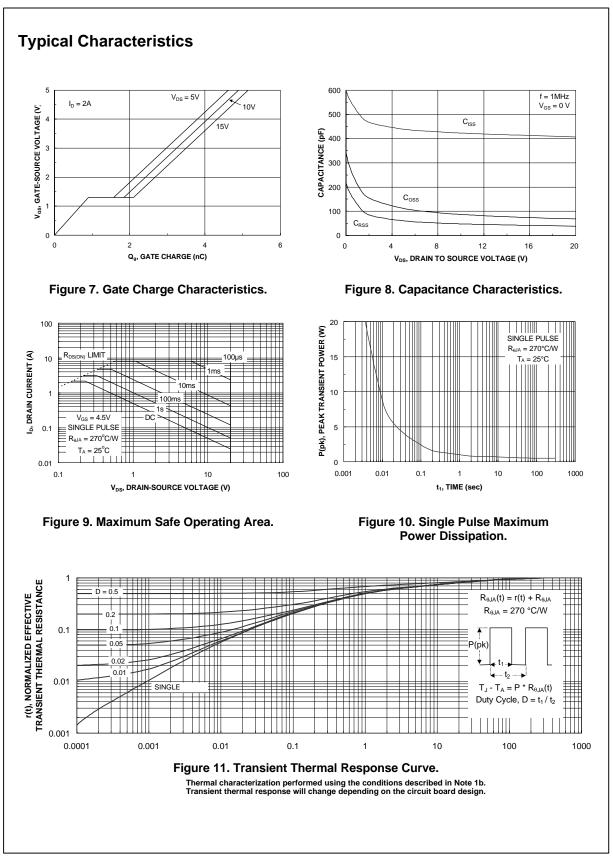
Scale 1 : 1 on letter size paper

2. Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2.0%

FDN327N Rev C (W)



FDN327N



FDN327N

FDN327N Rev C (W)

TRADEMARKS

The following are registered and unregistered trademarks Fairchild Semiconductor owns or is authorized to use and is not intended to be an exhaustive list of all such trademarks.

ACEx™ Bottomless™ CoolFET™ CROSSVOLT™ DenseTrench™ DOME™ **EcoSPARK™** E²CMOS[™] EnSigna™ FACT™ FACT Quiet Series™ FAST ® FASTr™ FRFET™ GlobalOptoisolator[™] POP[™] GTO™ HiSeC™ ISOPLANAR™ LittleFET™ MicroFET™ MicroPak™ MICROWIRE™

OPTOLOGIC™ OPTOPLANAR™ PACMAN™ Power247™ PowerTrench[®] QFET™ QS™ QT Optoelectronics[™] Quiet Series[™] SILENT SWITCHER®

SMART START™ VCX™ STAR*POWER™ Stealth™ SuperSOT[™]-3 SuperSOT[™]-6 SuperSOT[™]-8 SyncFET™ TinyLogic™ TruTranslation[™] UHC™ UltraFET[®]

STAR*POWER is used under license

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY. FUNCTION OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in significant injury to the user.

2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

PRODUCT STATUS DEFINITIONS

Definition of Terms

Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
First Production	This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
Not In Production	This datasheet contains specifications on a product that has been discontinued by Fairchild semiconductor. The datasheet is printed for reference information only.
	In Design First Production Full Production

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Fairchild Semiconductor: